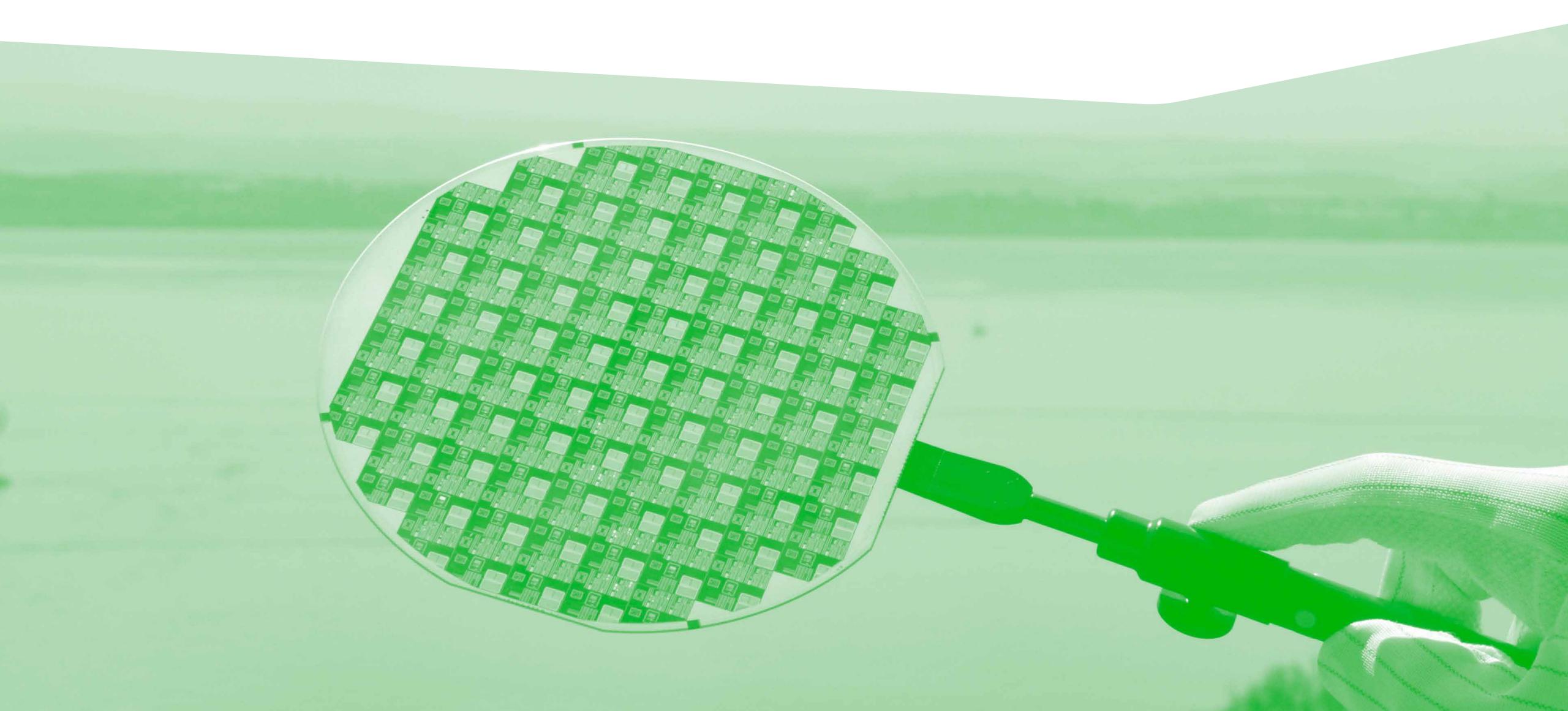
Eaptasic

MUCH MORE THAN ASIC TEST



Turnkey solutions ? The good news, is you have options



PRESENTATION OUTLINE

1. Company

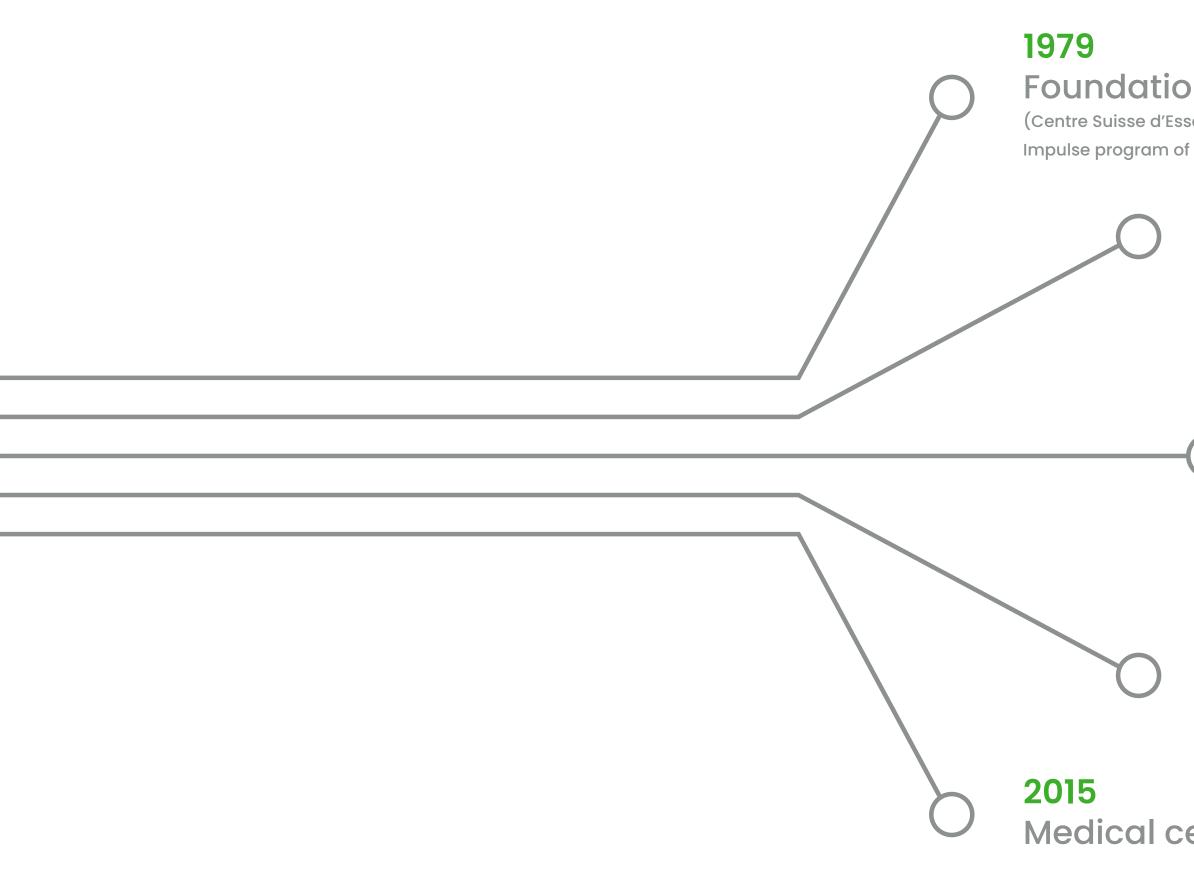
Evolution, location, statements, activities

- 2. Supply Chain Introduction, description
- 3. Equipment Clean room and modern equipment
- 4. References and sucess stories





COMPANY EVOLUTION





Foundation: CSEE (Public Entry)

(Centre Suisse d'Essais des composants Electroniques Impulse program of Swiss Confederation)

> 1992 **Private status: CSEE SA**

2006

Takeover: PQH Holding Certification: ISO9001

2008

Name change: Aptasic SA New facilities: Boudry

Medical certification: ISO13485



COMPANY LOCATION

Boudry (NE) Switzerland

Major features Building surface 1'400m²

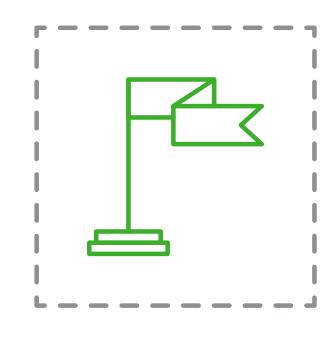
Clean room:

- 400m²
- Class 10K (ISO8)



• •

COMPANY **STATEMENTS**

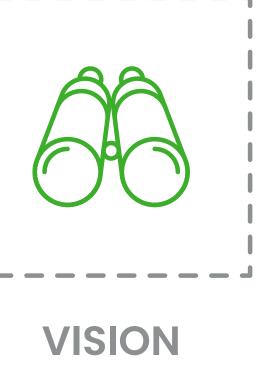


MISSION

Offer our customers, as main contractor, easy access to state-of-the-art foundries, assembly houses, production processes, technologies and consulting in the **semiconductor** industry

Enable our customers **first time right** production ramp-up, supporting smooth supply chain integration (from design to good packaged devices ready for use)

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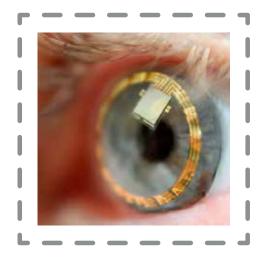




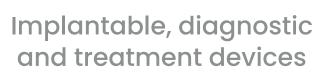
Because we strongly believe we can smooth the ASIC's industrialization process



COMPANY ACTIVITIES



MEDICAL





GREEN-TECH Photovoltaic panels



INDUSTRIAL Sensors, actuators, security, encryption



DIGITAL RF-ID, optoelectronic, digital

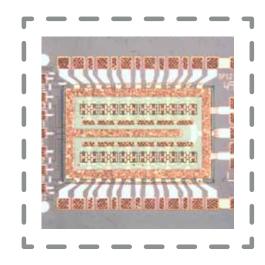


MILITARY/AEROSPACE

Sensors and converters



IMAGING X-Ray sensors, imagers



MEMS Membrane sensors, switches



COMPANY COMPETENCIES

Project managementComprehensive test solutions

SW development

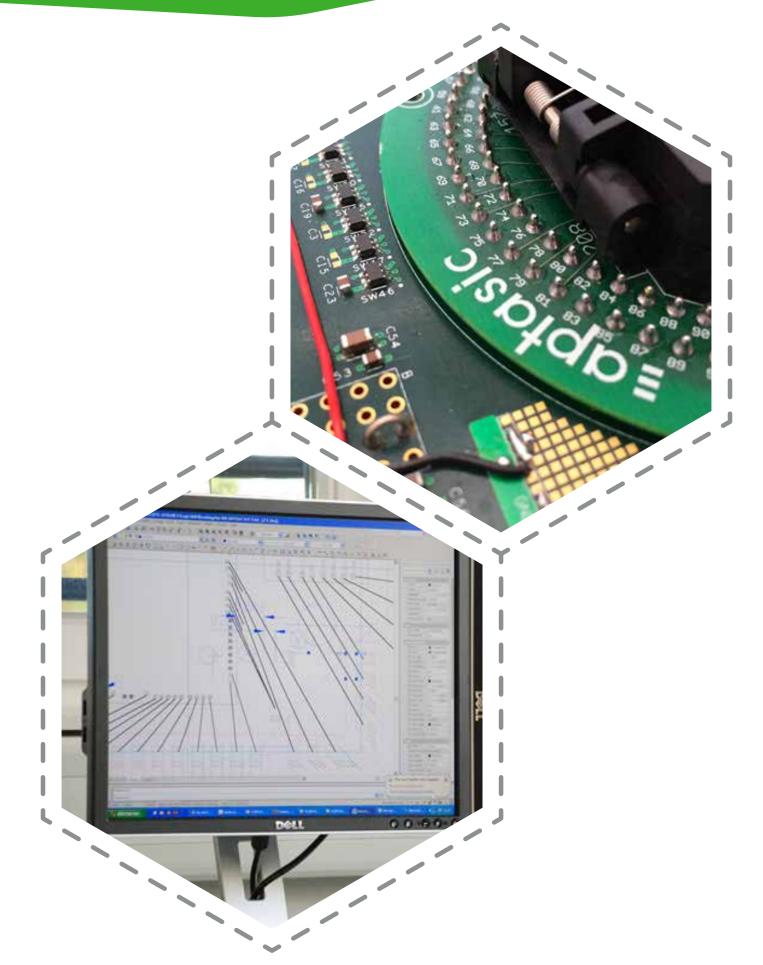
• Test program coding

HW development

- Load-Board
- Probe-Cards, PCB-Adapters

Screening flows and qualifications

- JEDEC
- MIL 883
- AEC-Q100







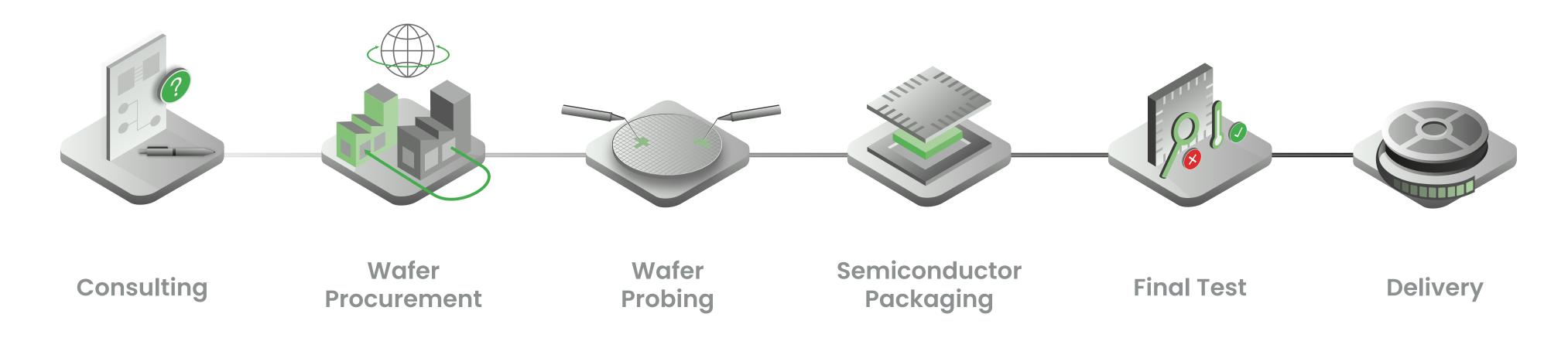
COMPANY **SUPPLY CHAIN INTRODUCTION**

Turnkey solutions to efficiently handle the ASIC supply chain :

- 100+ projects over the last 5 years
- Test programs development :
 - Analog/mixed signal (AMS), digital scan test, memory BIST, radio frequency (RF)
 - Experienced/knowledgeable engineers providing best services in ASIC test

Multi-site wafer probing at cold/room/hot (-40C° / 125-200C°)

Parallel package test at cold/room/hot (-40C°/150C°)









COMPANY **BUSINESS MODEL**

FLEXIBLE BUSINESS MODEL ACCORDING TO YOUR NEEDS

Turnkey Full ASIC Supply Chain \rightarrow From Consulting to Delivery

Contractor ASIC Supply Chain \rightarrow From Wafer Procurement to Delivery



On Demand

Based on your specific needs → From Consulting to Delivery, inluding Screening & Qualification services



SUPPLY CHAIN CONSULTING



WE CAN ADVISE FOR BETTER RESULTS

Needs

- ICs that are easy to test
 Increase accessiblity / observability
- Ensure predictable ICs response

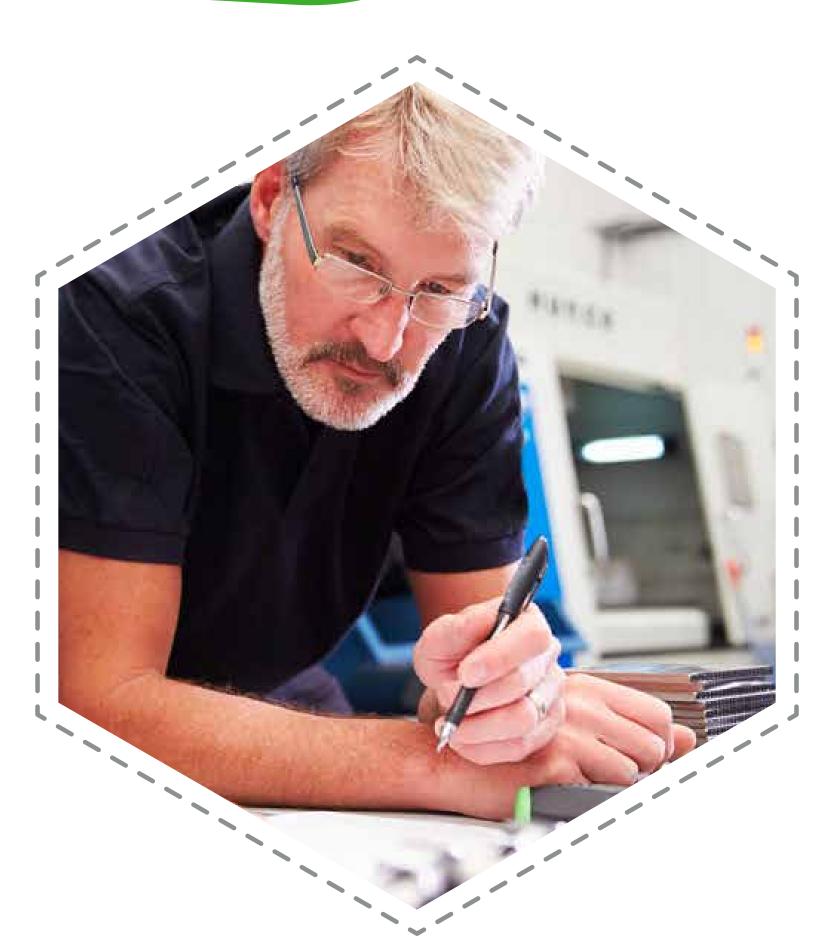
Targets

- Reduce test cost of complex ICs
- Reduce test development time
- Facilitate testing at system level
- Improve product quality
- Shorten time to market

Methods

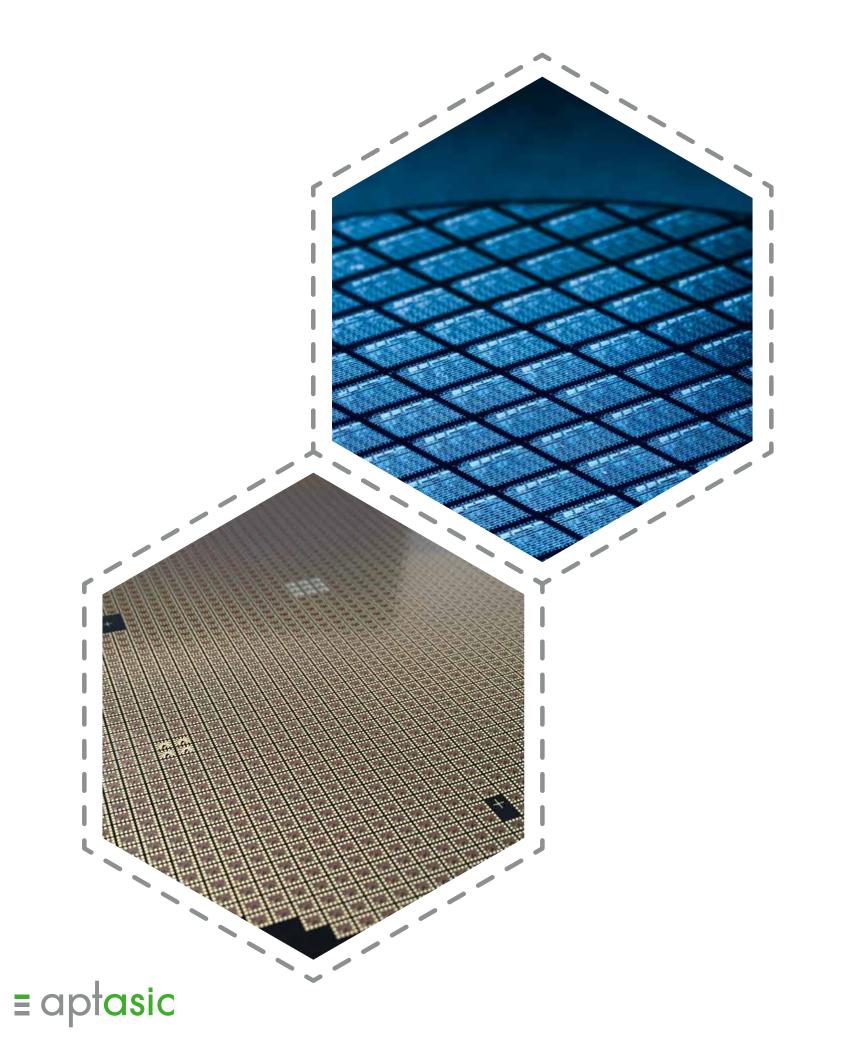
- Design for Testability
- Design for Assembly
 Design for Manufacturability

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SUPPLY CHAIN WAFER PROCUREMENT





DIRECT SOURCING FROM FOUNDRIES

Mature network of suppliers

Aptasic has established privileged contacts with the most important foundries to supply wafers from 1 um node to sub-micron technologies.

Our back-end network of OSAT support us for advanced packaging from low volume to mass production.

SUPPLY CHAIN WAFER PROBING



PROVIDING ELECTRICAL TEST FROM COLD TO HOT

Multi-site wafer probing

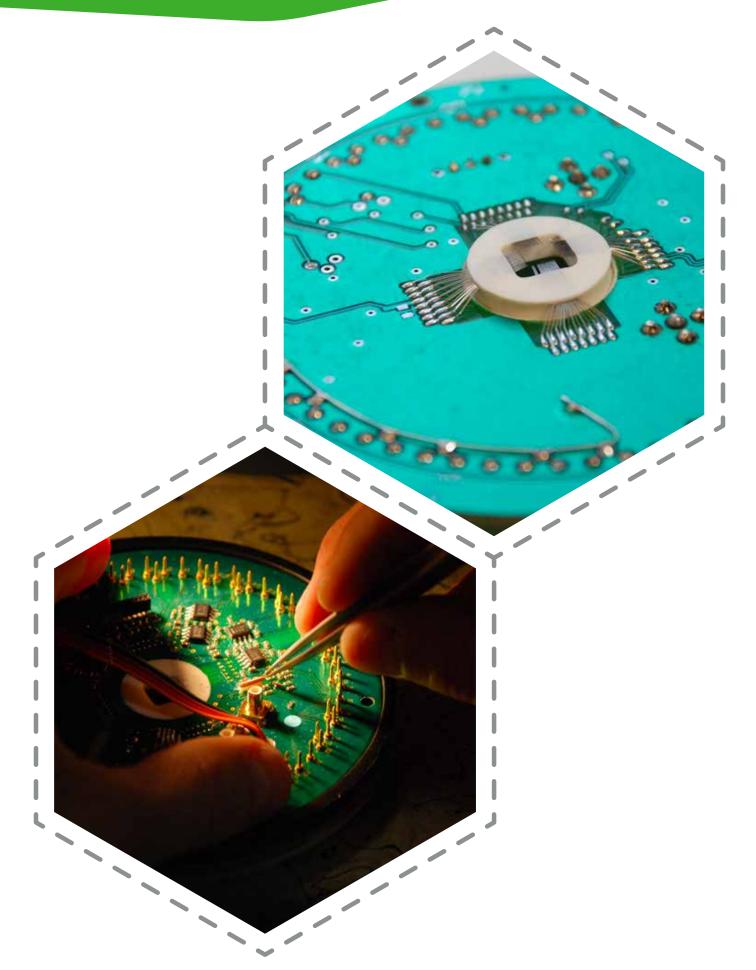
- 4" to 12" wafer diameter
- Cantilever and vertical probing

Test can be performed atCold / Ambient / Hot

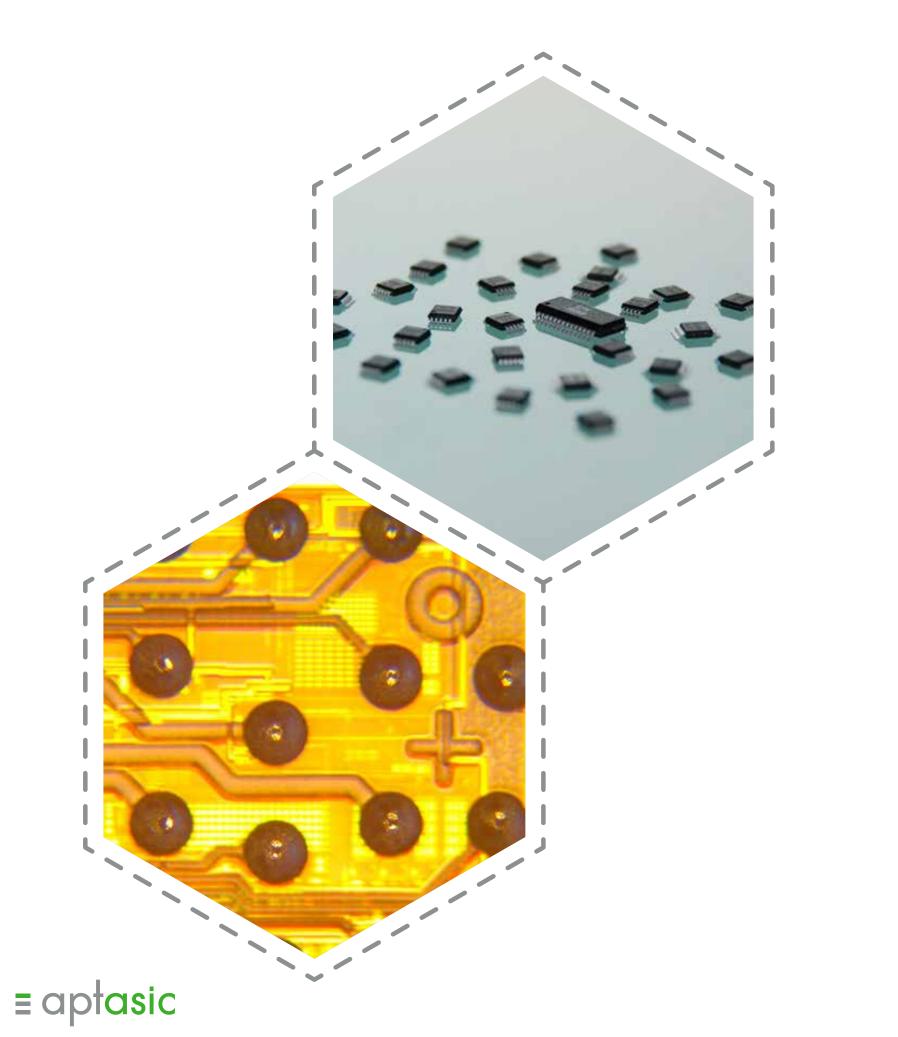
- Ranging from -40°C to 125-200°C

Dedicated hardware implementation

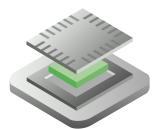
- DUT probe-cards
- Load-boards standards and custom



SUPPLY CHAIN SEMICONDUCTOR PACKAGING







PROVIDING FIRST CLASS PACKAGING AND HOUSING

Packages for prototyping

Open package families (ProtoPack™ technology)

Packages for low volume to mass production

- Laminate substrate packages
- Discrete package families
- Ceramic packages
- Standard package families
- Specific packages
- Multi die packages

Specific custom package developmentWafer Level Chip Scale (WLCS)

- System in Package (SiP)

SUPPLY CHAIN FINAL TEST



FINAL TEST TO ENSURE THE ASIC QUALITY

Aptasic performs the final test on packages offering a temperature range from -40°C to 150°C.

Our handlers are equipped for parallel test up to 4 sites and multiple binning options.

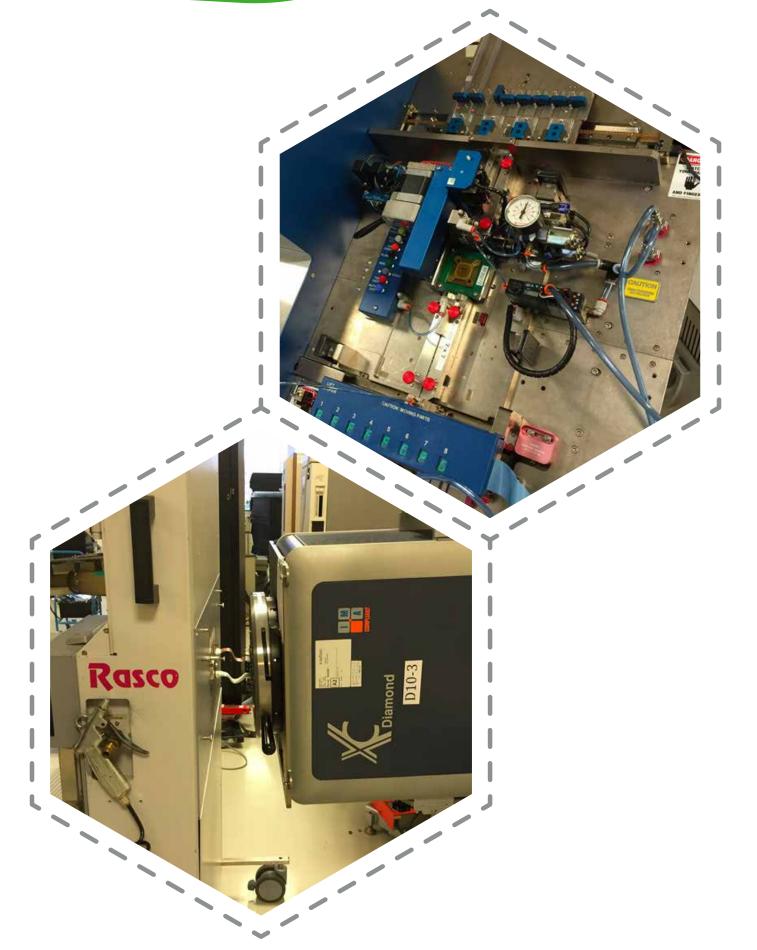
Dedicated hardware implementation

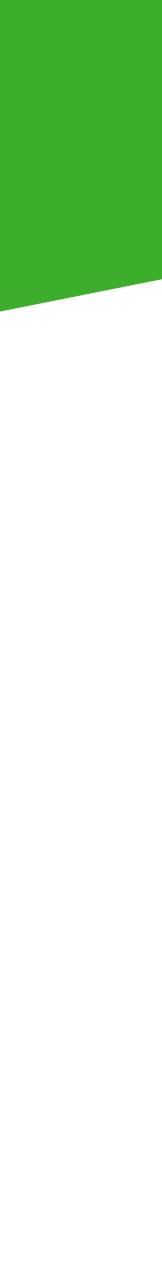
- DUT handler-cards
- Load-boards

Qualification & Screening

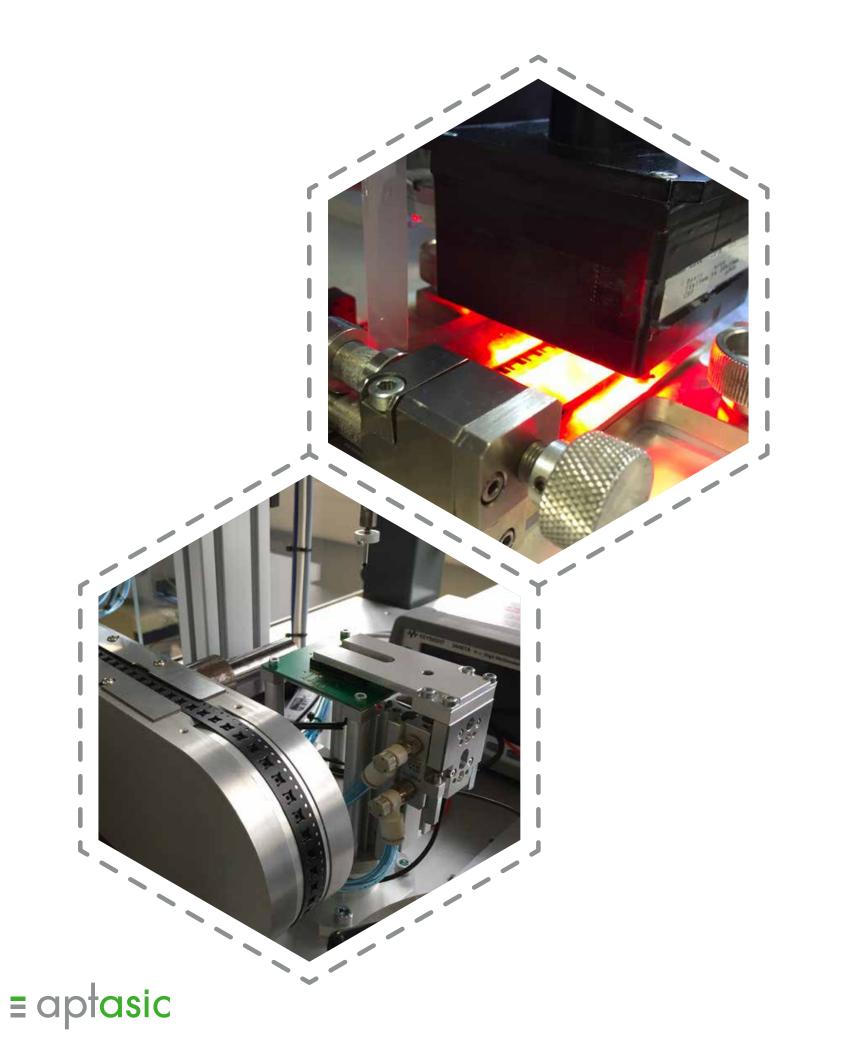
- JEDEC, MIL883 and AEC-Q100 standards
- In-house equipment
- Screening portfolio

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SUPPLY CHAIN DELIVERY





MOST COMMON WAY OF DELIVERING GOOD ICS

Tape & Reel

- Automated in-line
- Semi-automated
- Manual

Dedicated or standard tapes are available to precisely fit your requirements.

Pick & Place

- Fully-automated
- Handling multiple combinations of component's transfers

Automatic Optical Inspection secures the orientation and placement of each component.

EQUIPMENT **CLEAN ROOM**

Clean Room

Surface 400m² Class ISO8 - 10'000

Program to modernize infrastructure over last 5 years to achieve high efficiency and increase capacity and redundancy

List of purchases

- 1x Thermo-stream
- 4x XCerra (LTX-C D10 testers)
- 3x EG4090u 8" wafer probers
 2x RASCOs parallel test handler
- 1x UF-3000ex 12" wafer prober
- 1x AATEC pick and place with vibrant bowl
- Ix Panda Robot

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EQUIPMENT QUALIFICATION



JEDEC, MIL883 and AEC-Q100 standards

• 30 years experience (plastic & ceramic flows)

- In-house equipment
 Climatic-test / pressure / temperature chambers
 Burn-in / triple-chamber ovens

Screening portfolio

- BI, LT, TC, TH, HAST, PCT, SPP
- ESD, Latch-up



REFERENCES













Ω Metrohm ndd **ΡΗϿΝΑΚ**

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MUCH MORE THAN ASIC TEST



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